

ALPHA® OL107E

Solder Paste for Fine Pitch Stencil Printing

DESCRIPTION

ALPHA OL107E is a solder paste designed for stencil printing application in a surface mount process.

READ ENTIRE TECHNICAL DATA SHEET BEFORE USING THIS PRODUCT

FEATURES & BENEFITS

- Delivers consistent print performance even after 8 hours of continuous use
- Excellent fine-feature cosmetics demonstrated by bright, shiny joints
- Clear, colorless flux residues engineered not to spread onto either the board or components providing satisfactory pint testing
- Provides fine feature print volume consistency to 0.4 mm pitch QFPs even after one hour of downtime
- Excellent solder spread
- Exceeds both JIS and IPC requirements for random solder balling

PRODUCT INFORMATION

Alloys: Sn63Pb37, NT4S, Sn62Pb36Ag2

Powder Size: Type 3 (25 to 45 μm), Type 4 (20 to 38 μm)

Packaging Sizes: 500 gram & 6 inch cartridges

Flux Gels: Flux gel is available in 30 cc syringes for rework applications

Note 1: For other alloys, powder size and packaging sizes, contact your local

Alpha Sales Office.

APPLICATION GUIDELINES

Formulated for standard and fine pitch printing through stencil apertures as small as 0.125 mm (5 mil). ALPHA OL107E is designed to provide high post-reflow yield while maintaining excellent solder joint cosmetics.







TECHNICAL DATA

| Category | Results | Procedures/Remarks | | |
|---------------------------------------|---|--|--|--|
| Chemical Properties | | | | |
| Activity Level | ROL0 | IPC J-STD-004 | | |
| Halide Content | Halide free (by titration), Passes Ag Chromate Test | MIL-F-14256 | | |
| Fluoride Spot Test | Pass | MIL-F-14256 | | |
| Copper Mirror & Copper Corrosion Test | Pass | JIS Z 3197 | | |
| Electrical Properties | | | | |
| SIR (7 days, 85 °C/85%RH) | Pass; 4.2 x 10 ⁹ ohms | IPC J-STD-004 (Pass > 1 x 10 ⁸ ohm) | | |
| SIR (96hrs @35°C/85%RH) | Pass; 1.7 x 10 ¹³ ohms | Bellcore GR-78-CORE (Pass ≥ 1 x 10 ¹¹ ohm) | | |
| Physical Properties | | | | |
| Color | Clear, Colorless Flux Residue | | | |
| Tackiness Test | ≥95 gf for 24 hours | JIS Z 3284 | | |
| Solder Ball | Pass | IPC J-STD-005; JIS Z 3284 | | |
| Spreading Test | 94% for Sn63Pb37 | JIS Z 3197 | | |
| Stencil Life | 8 hours | @ 50% RH 23 °C (74 °C) | | |
| Hot Slump | Pass; No bridge for 0.2 mm space | JIS Z 3284 | | |



PROCESSING GUIDELINES

| Storage & Handling | Printing | Reflow (see Fig. 1) | Cleaning |
|--|---|--|---|
| Refrigerate to guarantee stability @ 0 to 10 °C (32 to 50 °F). When stored under these conditions, the shelf life of ALPHA OL107E is 4 months. When refrigerated, warm up paste container to room temperature for up to 4 hours. Paste must be 20 °C (68 °F) before processing. Verify paste temperature with a thermometer to ensure paste is at 20 °C (68 °F) to 23 °C (73.4 °F) before setting up of printer. Recommended operating conditions for ALPHA OL107E is 23 to 25 °C (73.4 to 77 °F) and 40 to 60% RH. Do not remove worked paste from stencil and mix with unused paste in jar. This will alter the rheology of unused paste. These are starting recommendations and all process settings should be reviewed independently. | Stencil: Recommend ALPHA CUT or ALPHA FORM stencils @ 0.125 mm (5 mil) thick. Stencil design is subject to many process variables. Contact your local Alpha stencil site for advice. Squeegee: Metal (recommended) Pressure: 0.29 to 0.47 kg/cm of squeegee length Speed: 25 to 200 mm per second (1 to 8 inches per second). Paste Roll: 1.5 to 2.0 cm diameter and make additions when roll reaches 1-cm (0.4 in) diameter (min). Max roll size will depend upon blade. | Atmosphere: Clean-dry air or nitrogen atmosphere. Profile: Please see profile chart below for ALPHA OL107E Sn63Pb37 Typical Reflow Profile. | residue is designed to remain on the board after reflow. Misprints and soft flux residues remaining after rework may be removed using semi-aqueous cleaners. |



REFLOW PROFILES

Figure 1 - General Soak Reflow Profile Recommendation 260 240 Peak Temp: 210°C - 230°C 220 200 Liquidus: 183°C 180 Temp (deg C) 160 140 120 Soak: 130°C to 160°C 100 for 60-90 sec 80 60 Ramp Rate: 1-2°C/sec 40 20 0 0 1 2 3 4 5 Time (min)



RECYCLING SERVICES

We provide safe and efficient recycling services to help companies meet their environmental and legislative requirements and at the same time, maximize the value of their waste streams.

Our service collects solder dross, solder scrap, and various forms of solder paste waste. Please contact your local sales representative for recycling capabilities in your area or link here.



SAFETY & WARNING

It is recommended that the company/operator read and review the Safety Data Sheets for the appropriate health and safety warnings before use. **Safety Data Sheets are available at MacdermidAlpha.com/assembly-solutions/knowledge-base.**

STORAGE

ALPHA OL107E is shipped in thermally controlled boxes and should be stored refrigerated upon receipt at 0 to 10 °C (32 to 50 °F), which will be sufficient to maintain a nominal shelf life of four months. ALPHA OL107E should be permitted to reach room temperature before unsealing its package prior to use (see handling procedures on page 3). This will prevent moisture condensation build up in the solder paste.

CONTACT INFORMATION

To confirm this document is the most recent version, please contact Assembly@MacDermidAlpha.com

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588

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